ASSOCIATION CONNE	Material Comp © Copyright 2005. I international and Par	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
1752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					erials and N	ials and Mfg Information			
Supplier Info	ormation														
Company name* Company unique ID					Unique ID Authority					Respon	Response Date*				
nsemi											2023-0	2023-06-08			
Contact Name			Title - Contact			Pho	Phone - Contact*				Email	Email - Contact*			
Product-Env-St	tewards		Product Enviro Compliance			NA.	NA				Produ	Product-Env-Stewards@onsemi.com			
uthorized Rep	resentative*		Title - Representative			Pho	Phone - Representative*				Email	Email - Representative*			
Product-Env-St	tewards	Product Env	Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com				
Requ	uester Item Number	Mfr Item	n Number	Mfr Item Name		Ef	ffective Date	Version	.]	Manufacturing Site		Weight*	UOM	Unit Type	
		NCD981	NCD9812MNTXG Multichannel ADC. Sensors with I2C &		C, DACs and Temperat & SPI interface	ure 20)23-06-08	PH1			330.25	mg	Each		
Ianufacturi	ng Proccess Informa	tion													
Terminal Plating / Grid Array Material			Ferminal Base Alloy J-STD-020 MSL		J-STD-020 MSL Rating	ţ	Peak Process Body Temperature Max Time at Pe		ık Tempera	ature Numb	per of Reflow Cyc	eles			
Matte Tin (Sn) - annealed		CU Alloy 3		3		260		C	30	seco	onds 3				
omments															
TTENTION: N	MSL 3 Rated item require	s Bake and D	Pry Pack (after	r electrical test)											
or more inform	nation regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of						
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	10.5	mg	Supplier	Silicon (Si)	7440-21-3		10.5	mg
Die Attach	4.5	mg	Supplier	Silver (Ag)	7440-22-4		3.375	mg
			Supplier	Epoxy resins	129915-35-1		1.125	mg
Lead Frame	70.5	mg	Supplier	Silver (Ag)	7440-22-4		3.384	mg
			Supplier	Zinc (Zn)	7440-66-6		0.141	mg
			Supplier	Iron (Fe)	7439-89-6		1.692	mg
			Supplier	Copper (Cu)	7440-50-8		65.283	mg
Mold Compound-Black	242.43	mg		Epoxy Phenol Resin	proprietary data		25.4551	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		216.9748	mg
Plating	1.58	mg	Supplier	Tin (Sn)	7440-31-5		1.58	mg
Wire Bond	0.74	mg	Supplier	Palladium (Pd)	7440-05-3		0.0074	mg
			Supplier	Copper (Cu)	7440-50-8		0.7326	mg